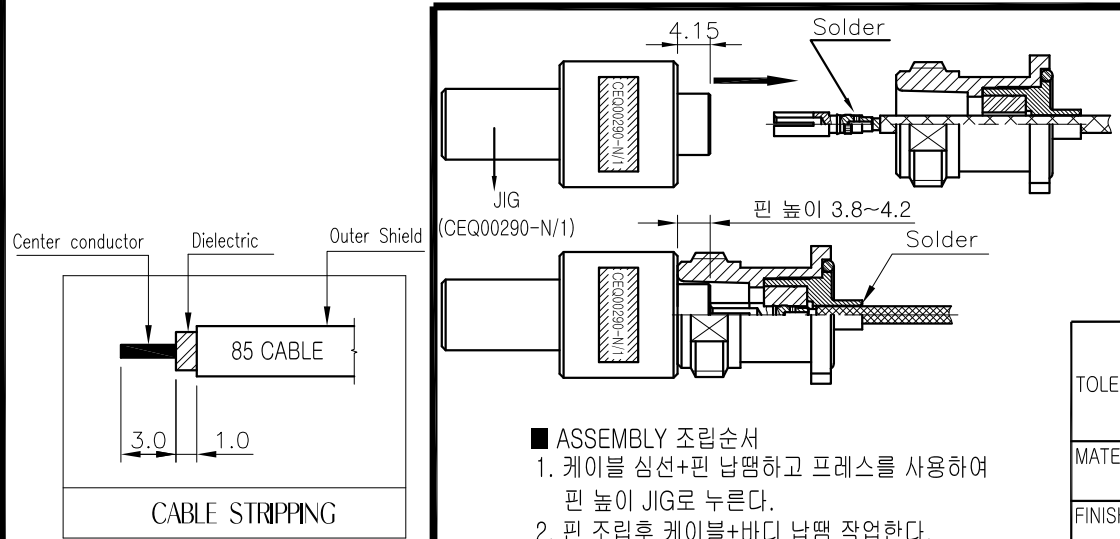
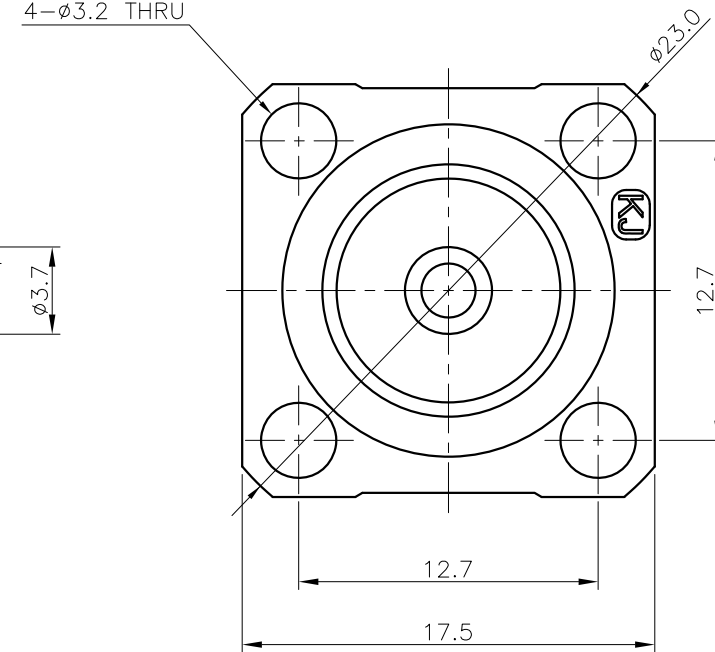
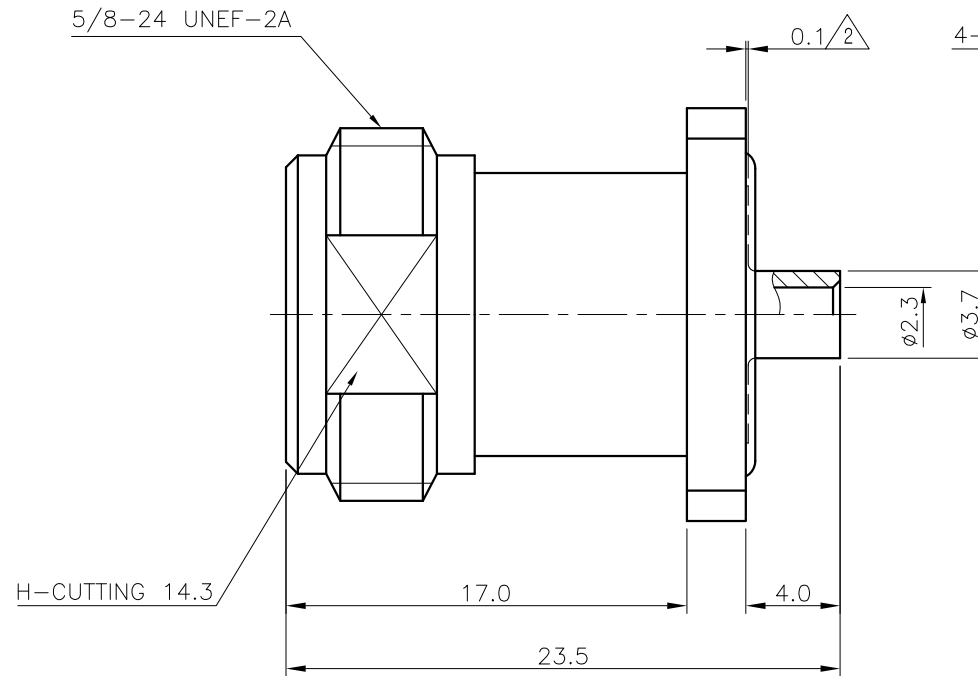


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2020.06.30.
1	[설변No.202012-0002] O-RING 빠짐 개선 안착부 금형수정	I.C.KIM		2020.12.07.
2	[설변No.202101-0003] O-RING 빠짐 개선 안착부 0.1mm Ground Boss 추가	S.Y.EUN	I.C.KIM	2021.01.20.



5	INSULATOR	1	TEFLON		DIN03153-N/1
4	GASKET	1	SILICONE Rub		DGK00257-N/2 DGK00032-N/1
3	CONTACT	1	BeCu C17300	Gold Plate	DCT02735-5/5
2	BODY	1	MBsBD C3604BD-F	Nickel Plate (납땜성향상)	DBD02996-5/6 DBD02996-5/4
1	BODY	1	ZnDC	Nickel Plate (3~4μm)	DBD02992-5/3 DBD02992-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2021. 01. 20.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY I.C.KIM			
MATERIAL _____		CHECKED BY			TITLE N50 CABLE JS-4H 85F
		DRAWN BY S.Y.EUN			
FINISH _____		SCALE 3/1	UNIT mm		A4
				REVISION 2	SHEET 1 of 1